

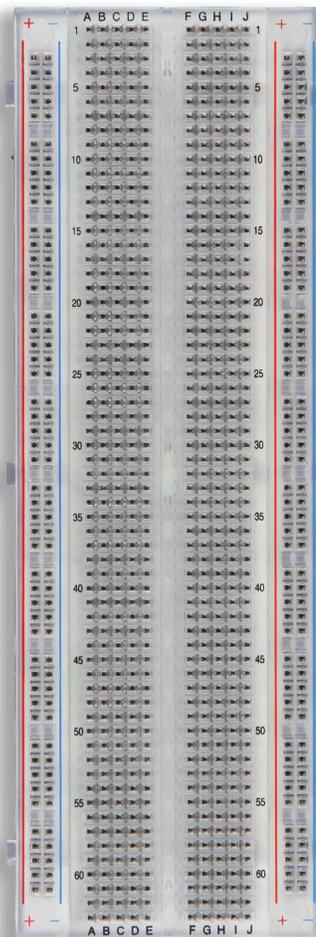
GS-630T

630T TIE-POINT, SOLDERLESS BREADBOARD

Applications

The GS-630T is a modular type solderless breadboard that connects with the GS-100T bus strip to make a 830 tie point breadboard (GS-830T). Expandable, it is a great way to prototype low frequency or DC powered circuits. It is ideal for:

- Educational labs
- Hobbyists



Features

- 630 Tie-points
- Transparent ABS plastic body
- Square hole style
- Interlocking tabs
- Peel and stick adhesive
- Nickel plated phosphor bronze spring clip contacts
- Allowable wire diameter of 0.4-0.7 mm
- Fits 7 total 16-pin ICs
- Measures 6.5 x 1.375 x 0.33 in
- Maximum capacity of 1.5 A at 36 V
- RoHS compliant
- Three-year warranty

GS-630T

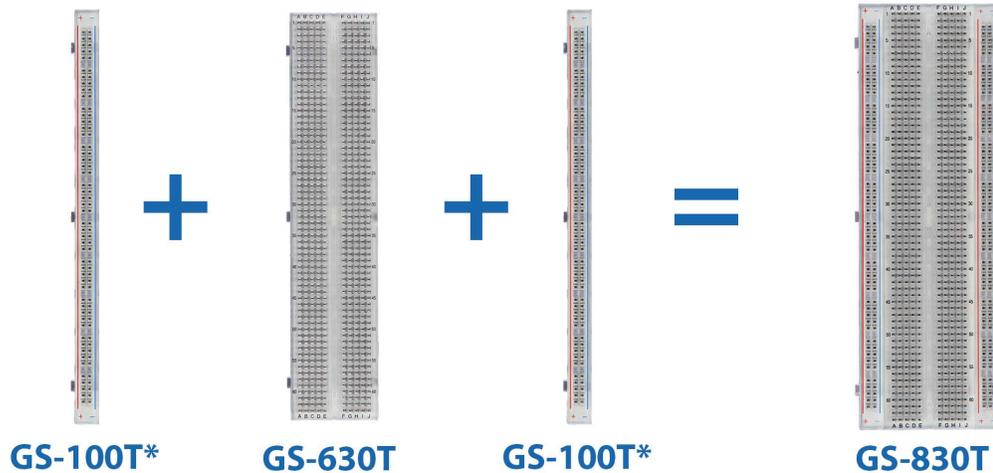
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GS-830T Components



*The GS-100T is sold as a pack of two